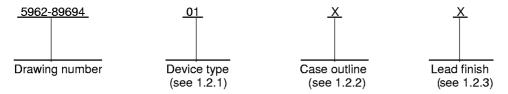
					F	REVIS	IONS										
LTR	DESCRIPTION							DA	ATE (Y	'R-MO-I	DA)		APPR	OVE)		
查询"	962-8969401E/ Add device type throughout.	3"供協意	e boiler	plate.	Edito	rial co	rrectio	ns		98-10-16				Raymond Monnin			
В	Add case outline	e "Y" to dra	wing 🤉	glg						00-0	1-19			Ray	mond N	Monnii	n
					ı		1	ı	ı			ı	1	ı			
REV																	-
SHEET	+		_			_											
REV			+														-
SHEET		55,4			_	<u> </u>	_		_			_	_				<u> </u>
REV STATU OF SHEETS		REV		В	В	В	В	В	В	B -	В	В	В		\vdash		
PMIC N/A		SHEET PREPAF Kenn			2	3	DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216										
MICRO	NDARD CIRCUIT	CHECKE Charl	ED BY es Reus	sing													
THIS DRAWII FOR U	AWING NG IS AVAILABLE ISE BY ALL	APPRO\ Micha	/ED BY ael A. Fr			MICROCIRCUIT, MEMORY, DIGITAL, OSRAM, MONOLITHIC SILICON			L, CM	IOS, 1	6 X 4						
DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE		DRAWIN	IG APP 10 Aug			E	SIZE CAGE CO			E CODE 50		50	962-89694				
AMSC	N/A	REVISIO	N LEVE	ΞL				4	6	<u>726</u>	8			,UZ-			
			В				SHE	EΤ	1	(OF	1	0				

1. SCOPE

查诊验 Description of the property of the proper

1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example:



1.2.1 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows:

Device type	Generic number	Circuit function	Acces time
01	7C190	16 X 4 SRAM	25 ns
02	7C190-30	16 X 4 SRAM	30 ns

1.2.2 <u>Case outline(s)</u>. The case outline(s) are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	<u>Terminals</u>	Package style
E	GDIP1-T16 or CDIP2-T16	16	Dual-in-line package
F	GDFP2-F16 or CDFP3-F16	16	Flat package
Χ	CQCC2-N20	20	Square chip carrier package 1/
Υ	CQCC2-N20	20	Square chip carrier package $\frac{1}{1}$

- 1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.
- 1.3 Absolute maximum ratings.

Supply voltage to ground potential	-0.5 V dc to +7.0 V dc -0.5 V dc to +7.0 V dc -3.0 V dc to +7.0 V dc
DC output current Maximum power dissipation 1/	20 mA 500 mW
Lead temperature (soldering, 10 seconds) Thermal resistance, junction-to-case (Θ _{JC}):	+260°C See MIL-STD-1835 +150°C
Storage temperature range Temperature under bias	-65° C to +150° C -55° C to +125° C

1.4 Recommended operating conditions.

Supply voltage (V _{CC})Ground voltage (GND)	+4.5 V dc to +5.5 V dc
	0 V dc
Input high voltage (V _{IH})	2.0 V dc minimum
Input low voltage (V _{II})	0.8 V dc maximum
Operating case temperature range (T _C)	-55°C to +125°C

See Figure 1 terminal connections for pinout differences.
 Must withstand the added P_D due to short circuit test (e.g., I_{OS}).
 Maximum junction temperature may be increased to 175°C during burn-in and steady state life.

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2. APPLICABLE DOCUMENTS

The Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

DEPARTMENT OF DEFENSE

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-973 - Configuration Management.

MIL-STD-1835 - Interface Standard For Microcircuit Case Outlines.

HANDBOOKS

DEPARTMENT OF DEFENSE

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.
 - 3.2.1 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.
 - 3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.3 Truth table. The truth table shall be as specified on figure 2.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

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- 3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103 (see 6.6 herein). For packages where grave points and provided in the manufacturer has the option of not marking the "5962" on the device.
- 3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.
- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 <u>Notification of change</u>. Notification of change to DSCC-VA shall be required in accordance with MIL-PRF-38535, appendix A.
- 3.9 <u>Verification and review</u>. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.
 - (2) $TA = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C_{IN} and C_{OUT} measurement) shall be measured only for the initial test and after process or design changes which may affect input capacitance.
- d. Subgroups 7 and 8 shall include verification of the truth table.

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		TABLE I. <u>Electrical performance cha</u>	aracteristics.				
查询"5962-8969401E	人"供应	Conditions 1/	Group A	Device	Limits		Unit
	Суппол	-55° C \leq T $_{C} \leq$ +125 $^{\circ}$ C 4.5 V \leq V $_{CC} \leq$ 5.5 V unless otherwise specified	subgroups	type	Min	Max	Onit
Output high voltage	v _{OH}	$V_{CC} = 4.5 \text{ V}, I_{OH} = -5.2 \text{ mA},$ $V_{IN} = V_{IH}, V_{IL}$	1,2,3	All	2.4		V
Output low voltage	v _{OL}	$V_{CC} = 4.5 \text{ V}, I_{OL} = 16 \text{ mA}, V_{IN} = V_{IH}, V_{IL}$	1,2,3	All		0.45	V
Input high voltage 2/	v _{IH}		1,2,3	All	2.0		V
Input low voltage 2/	V _{IL}		1,2,3	All		0.8	V
Input leakage current	I _{IX}	V _{IN} = 5.5 V to GND	1,2,3	All	-10	10	μА
Output leakage current	loz	$V_{OUT} = 5.5 \text{ V to GND}, V_{CC} = 5.5 \text{ V}$	1,2,3	All	-40	40	μΑ
Output short circuit current <u>3</u> / <u>4</u> /	los	V _{CC} = 5.5 V, V _{OUT} = GND	1,2,3	All		-90	m A
Operating supply current	lcc	V _{CC} = 5.5 V, I _{OUT} = 0 mA	1,2,3	All		70	mA
Input capacitance 4/	c _{IN}	V ₁ = 0.0 V. V _{CC} = 5.5 V	4	01		4	pF
	I	$V_{I} = 0.0 \text{ V}, V_{CC} = 5.5 \text{ V}$ $T_{A} = +25^{\circ}\text{ C}, f = 1 \text{ Mhz}, (\text{see } 4.3.1\text{c})$		02		8	
Output capacitance 4/	C _{OUT}	V _O = 0 V, V _O C = 5.5 V	4	01		7	pF
,	001	$V_{O} = 0 \text{ V}, V_{CC} = 5.5 \text{ V}$ $T_{A} = +25^{\circ}\text{ C}, f = 1 \text{ Mhz}, (\text{see } 4.3.1\text{c})$		02		8	
Read cycle time	t _{RC}	See figure 4.	9, 10, 11	01	25		ns

See footnotes at end of table.

Chip select to output

Chip select inactive 4/5/

Chip select active to 4/

Output hold from address

valid

to high Z

low Z

change

t_{ACS}

t_{HZCS}

t_{LZCS}

^tOHA

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02

01

02

ΑII

ΑII

ΑII

9, 10, 11

9, 10, 11

9, 10, 11

9, 10, 11

30

5

15

20

15

15

ns

ns

ns

ns

TABLE I. <u>Electrical performance characteristics</u> - Continued.

查询"5962-8969401E	A"供应商	Conditions 1/	Group A	Device	Lim	nits	Unit
rest	Symbol	-55° C \leq T _C \leq +125° C 4.5 V \leq V _{CC} \leq 5.5 V unless otherwise specified	subgroups	type	Min	Max	Offic
Address access time	t _{AA}	See figure 4.	9, 10, 11	01		25	ns
Write cycle time	t _{WC}		9, 10, 11	01	20 30		ns
Write enable active 4/ 5/ to high Z	t _{HZWE}		9, 10, 11	All		20	ns
Write enable inactive 4/ to low Z	t _{LZWE}		9, 10, 11	All		20	ns
Write enable inactive to output valid	^t AWE		9, 10, 11	All		20	ns
Write enable pulse width	^t PWE		9, 10, 11	All	20		ns
Data setup to write end	t _{SD}		9, 10, 11	All	20		ns
Data hold from write end	^t HD		9, 10, 11	All	0		ns
Address setup to write start	t _{SA}		9, 10, 11	All	0		ns
Address hold from write end	^t HA		9, 10, 11	All	0		ns

^{1/} AC tests are performed with input rise and fall times of 5 ns or less, timing references levels of 1.5 V, input pulse levels of 0 to 3.0 v, and the output load in figure 3, circuit a.

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These are absolute values with respect to device ground and all overshoots due to system or tester noise are included.

Not more than 1 output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.

Tested initially and after any design or process changes that affect that parameter, and therefore shall be

guaranteed to the limits specified in table I.

Transition is measured at steady state high level -500 mV or steady state low level +500 mV on the output from 1.5 V level on the input with the load in figure 3, circuit b.

查询"5962-8969401EA"供应商

Device types	All		
Case outlines	E, F	Х	Υ
Terminal number	Terminal symbol		
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20	A ₀ S WE D ₀ O ₁ O ₁ O ₁ O ₂ O ₃ O ₃ A ₂ A ₁ VCC	4 C Z B D O D Z O G O D Z O D A A Z A Z O C S O D A A Z A Z O C S O D A A Z A Z O C S O D A A Z A Z O C S O D A A Z A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C S O D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A Z O C D A A A A Z O C D A A A A Z O C D A A A A Z O C D A A A Z O C D A A A Z O C D A A A A Z O	C 60 E 10 1 20 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

NC = no connection

FIGURE 1. Terminal connections.

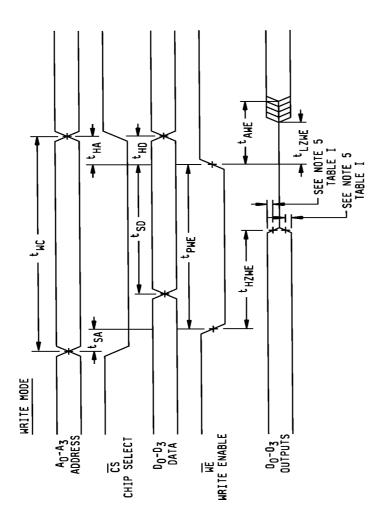
CE	WE	Mode	D _{OUT}	Power
Н	×	Not selected	High Z	Active
L	L	Write	High Z	Active
L	Н	Read	D _{OUT}	Active

FIGURE 3. Truth table.

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查询"5962-8969401EA"供应商 SEE NOTE TABLE I SEE NOTE TABLE I | t HZCS FIGURE 3. Output load circuit. FIGURE 4. Timing waveforms. 5 7 -OTU-TU0 t OHA R1 239ภ 30 pF TINCLUDING JIG AND SCOPE t Lzcs → 5 40 t RC OUTPUT O t AA -READ MODE CHIP SELECT SIZE **STANDARD** 5962-89694 Α **MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS** REVISION LEVEL B SHEET **COLUMBUS, OHIO 42316-5000** 8

FIGURE 4. Timing waveforms - Continued.



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TABLE II. Electrical test requirements.

查询"5962-8	9694ML与A均供透透。 requirements	Subgroups (per method 5005, table I)
	Interim electrical parameters (method 5004)	
	Final electrical test parameters (method 5004)	1*, 2, 3, (7*)***, (8A, 8B)***, 9, 10, 11
	Group A test requirements (method 5005)	1, 2, 3, 4**, 7***, (8A, 8B)***, 9, 10, 11
	Groups C and D end-point electrical parameters (method 5005)	2, 3, 7***,(8A, 8B)***

- * PDA applies to subgroup 1 and 7.
- ** Indicates subgroup 4 will only be performed during initial qualification and after any design or process changes that may affect capacitance (see 4.3.1c).
- *** See 4.3.1d.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
 - (2) $TA = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

5. PACKAGING

- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.
- 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.
- 6.4 <u>Record of users</u>. Military and industrial users shall inform Defense Supply Center Columbus when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0525.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0674.
- 6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in QML-38535 and MIL-HDBK-103. The vendors listed in QML-38535 and MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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DATE: 00-01-19

查询"5962-8969401EA"供应商
— Approved sources of supply for SMD 5962-89694 are listed below for immediate acquisition only and shall be added to QML-38535 and MIL-HDBK-103 during the next revision. QML-38535 and MIL-HDBK-103 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of QML-38535 and MIL-HDBK-103.

Standard microcircuit drawing part number 1/	Vendor CAGE number	Vendor similar part number <u>3</u> /
5962-8969401EX	<u>2</u> /	CY7C190-25DMB
5962-8969401FX	<u>2</u> /	CY7C190-25KMB
5962-8969401XX	<u>2</u> /	CY7C190-25LMB
5962-8969402EA	0DKS7	GEM25402BEA
5962-8969402EC	0DKS7	GEM25402BEC
5962-8969402FA	0DKS7	GEM25402BFA
5962-8969402FC	0DKS7	GEM25402BFC
5962-8969402XA	0DKS7	GEM25402BXA
5962-8969402XC	0DKS7	GEM25402BXC
5962-8969402YA	0DKS7	GEM25402BYA
5962-8969402YC	0DKS7	GEM25402BYC

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed, contact the Vendor to determine its availability.
- 2/ Not available from an approved source of supply.
- 3/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number

Vendor name and address

0DKS7

Sarnoff, David Research Center 201 Washington Road Princeton, NJ 08540-5300

The information contained herein is disseminated for convenience only and the Government assumes no liability whatsoever for any inaccuracies in the information bulletin.